

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2848	vacuum metallization	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	WITH	ON	2007/01/21 19:41
L2	79	vacuum metallization conductive adj layer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	WITH	ON	2007/01/21 19:54
L3	0	vacuum metallization conductive adj layer EMI	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	WITH	ON	2007/01/21 19:42
L4	0	vacuum metallization conductive adj layer board	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	WITH	ON	2007/01/21 19:43
L5	56	vacuum adj metallization conductive adj layer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	WITH	ON	2007/01/21 20:57
L6	1	29/846,825,831,832,841,848,855,856, 428,460,469,525.ccls. and vacuum adj metallization conductive adj layer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	WITH	ON	2007/01/21 20:58
L7	0	427/96,103,118,258,265.ccls. and vacuum adj metallization conductive adj layer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	WITH	ON	2007/01/21 20:59

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L8	0	174/35MS,35R,52.2.ccls. and vacuum adj metallization conductive adj layer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	WITH	ON	2007/01/21 21:00
L9	3	257/659,660.ccls. and vacuum adj metallization conductive adj layer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	WITH	ON	2007/01/21 21:00
L10	7	361/753,799,800,816.ccls. and vacuum adj metallization conductive adj layer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	WITH	ON	2007/01/21 21:00